

DMTH10H2M5STLWQ

100V 175°C N-CHANNEL ENHANCEMENT MODE MOSFET POWERDI1012-8 (TOLL)

Product Summary

BV _{DSS}	Rds(on) Max	Ι _D T _C = +25°C	
100V	2.5mΩ @ V _{GS} = 10V	215A	

Description and Applications

This MOSFET is designed to meet the stringent requirements of automotive applications. It is qualified to AEC-Q101, supported by a PPAP, and is ideal for use in:

- Motor Control
- DC-DC Converters
- Power Management

Features

- Rated to +175°C Ideal for High Ambient Temperature Environments
- 100% Unclamped Inductive Switching (UIS) Test in Production Ensures More Reliable and Robust End Application
- High Conversion Efficiency
- Low RDS(ON) Minimizes On State Losses
- Wettable Flank for Improved Optical Inspection
- Lead-Free Finish; RoHS Compliant (Notes 1 & 2)
- Halogen and Antimony Free. "Green" Device (Note 3)
- The DMTH10H2M5STLWQ is suitable for automotive applications requiring specific change control; this part is AEC-Q101 qualified, PPAP capable, and manufactured in IATF 16949 certified facilities.

https://www.diodes.com/quality/product-definitions/

Mechanical Data

- Case: POWERDI[®]1012-8 (TOLL)
- Case Material: Molded Plastic, "Green" Molding Compound. UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020
- Terminal Connections Indicator: See Diagram
- Terminals: Finish Matte Tin Annealed over Copper Leadframe. Solderable per MIL-STD-202, Method 208 (£3)

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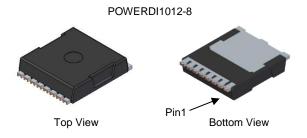
Top View

Pin Configuration

Weight: 0.388 grams (Approximate)

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Internal Schematic



Ordering Information (Note 4)

Part Number DMTH10H2M5STLWQ-13		Case	Packaging		
		POWERDI1012-8	1500/Tape & Reel		
Notes: 1. EU Directive 2002/95/EC (RoHS), 2011/65/EU (RoHS 2) & 2015/863/EU (RoHS 3) compliant. All applicable RoHS exemptions applied.					

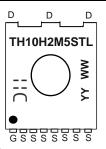
EU Directive 2002/95/EC (RoHS), 2011/65/EU (RoHS 2) & 2015/863/EU (RoHS 3) compliant. All applicable RoHS exemptions applied.
 See https://www.diodes.com/quality/lead-free/ for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and Lead-free.

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3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.

4. For packaging details, go to our website at https://www.diodes.com/design/support/packaging/diodes-packaging/.

Marking Information



):' = Manufacturer's Marking
TH10H2M5STL = Product Type Marking Code
YYWW = Date Code Marking
YY = Last Two Digits of Year (ex: 21 = 2021)
WW = Week Code (01 to 53)

PowerDI is a registered trademark of Diodes Incorporated. DMTH10H2M5STLWQ Document number: DS42468 Rev. 4 - 2

1 of 7 www.diodes.com D

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Maximum Ratings (@T_A = +25°C, unless otherwise specified.)

Characteristic	Symbol	Value	Unit	
Drain-Source Voltage	Vdss	100	V	
Gate-Source Voltage		V _{GSS}	±20	V
Continuous Drain Current (Note 6) V _{GS} = 10V	Tc = +25°C Tc = +100°C	ID	215 152	А
Pulsed Drain Current (10µs Pulse, Duty Cycle = 1%)	Ідм	860	А	
Maximum Continuous Body Diode Forward Current (Note 6)	bus Body Diode Forward Current (Note 6)		215	А
Pulsed Body Diode Forward Current (10µs Pulse, Duty Cycle = 1%)	ody Diode Forward Current (10µs Pulse, Duty Cycle = 1%)		860	А
Avalanche Current, L = 0.3mH	las	68	А	
Avalanche Energy, L = 0.3mH	Eas	701	mJ	

Thermal Characteristics

Characteristic		Symbol	Value	Unit
Total Power Dissipation (Note 5)	$T_A = +25^{\circ}C$	PD	5.8	W
Thermal Resistance, Junction to Ambient (Note 5)		Reja	26	°C/W
Total Power Dissipation (Note 6)	Tc = +25°C	PD	230.8	W
Thermal Resistance, Junction to Case (Note 6)	Rejc	0.65	°C/W	
Operating and Storage Temperature Range	TJ, TSTG	-55 to +175	°C	

Electrical Characteristics (@T_A = +25°C, unless otherwise specified.)

Characteristic	Symbol	Min	Тур	Max	Unit	Test Condition	
OFF CHARACTERISTICS (Note 7)							
Drain-Source Breakdown Voltage	BV _{DSS}	100	_		V	$V_{GS} = 0V, I_D = 1mA$	
Zero Gate Voltage Drain Current	IDSS	_	—	1	μA	V _{DS} = 80V, V _{GS} = 0V	
Gate-Source Leakage	lgss	_	—	±100	nA	$V_{GS} = \pm 20V, V_{DS} = 0V$	
ON CHARACTERISTICS (Note 7)							
Gate Threshold Voltage	Vgs(th)	2	—	4	V	$V_{DS} = V_{GS}$, $I_D = 250 \mu A$	
Static Drain-Source On-Resistance	RDS(ON)	_	1.68	2.5	mΩ	V _{GS} = 10V, I _D = 30A	
Diode Forward Voltage	Vsd	_	0.8	1.2	V	V _{GS} = 0V, I _S = 30A	
DYNAMIC CHARACTERISTICS (Note 8)							
Input Capacitance	Ciss	_	8450	_		$V_{DS} = 50V, V_{GS} = 0V$ f = 1MHz	
Output Capacitance	Coss	—	2430	_	pF		
Reverse Transfer Capacitance	Crss	—	17.7	—			
Gate Resistance	Rg	—	1.0	—	Ω	$V_{DS} = 0V$, $V_{GS} = 0V$, $f = 1MHz$	
Total Gate Charge	Qg	—	124.4	—			
Gate-Source Charge	Q _{gs}	—	34	—	nC	$V_{DD} = 50V, I_D = 30A,$ $V_{GS} = 10V$	
Gate-Drain Charge	Q _{gd}	—	28.3	—		VGS = 10V	
Turn-On Delay Time	tD(ON)	—	32.7	—			
Turn-On Rise Time	tR	_	47	_		$V_{DD} = 50V, V_{GS} = 10V,$ $I_D = 30A, R_G = 4.7\Omega$	
Turn-Off Delay Time	tD(OFF)	_	91.3	_	ns		
Turn-Off Fall Time	tF	_	53.9	_			
Reverse Recovery Time	t _{RR}	_	87.6	_	ns	I _F = 25A, di/dt = 100A/µs	
Reverse Recovery Charge	Q _{RR}	_	251.8	_	nC		

Notes: 5. Device mounted on FR-4 substrate PC board, 2oz copper, with thermal bias to bottom layer 1inch square copper plate.

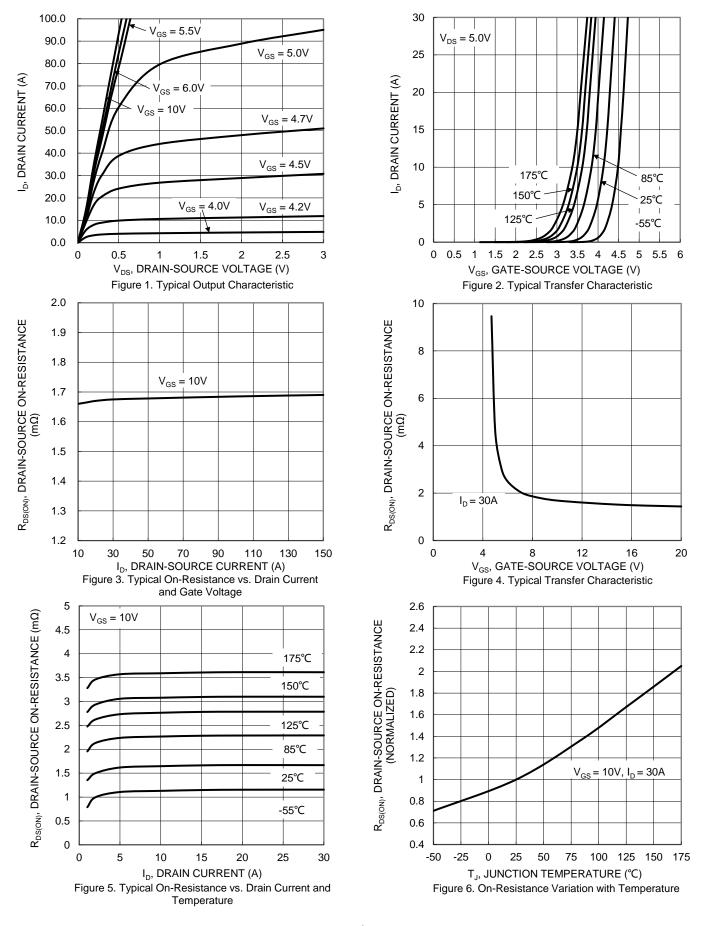
6. Thermal resistance from junction to soldering point (on the exposed drain pad).

7. Short duration pulse test used to minimize self-heating effect.

8. Guaranteed by design. Not subject to product testing.

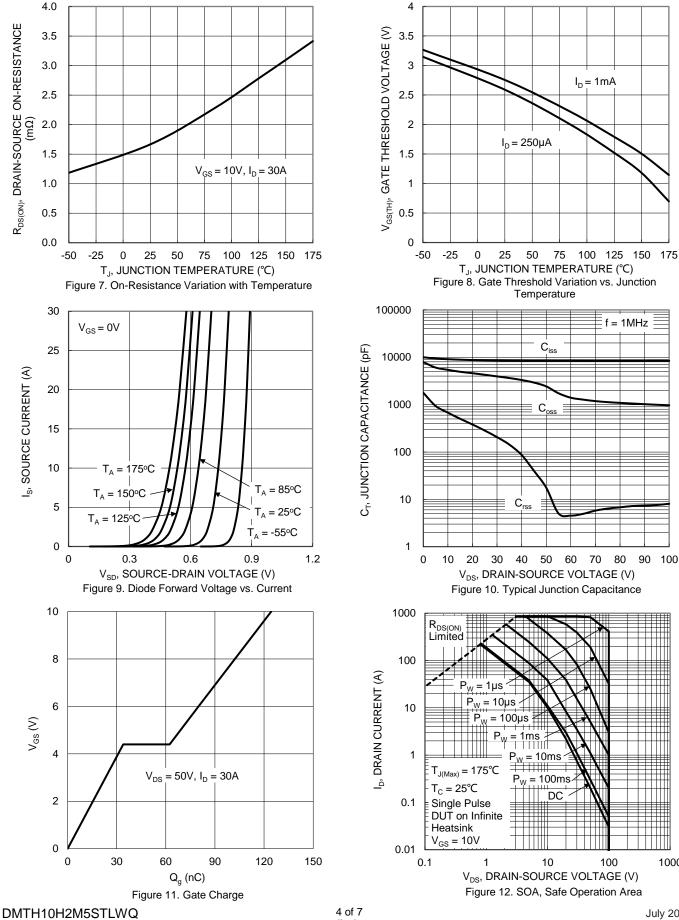


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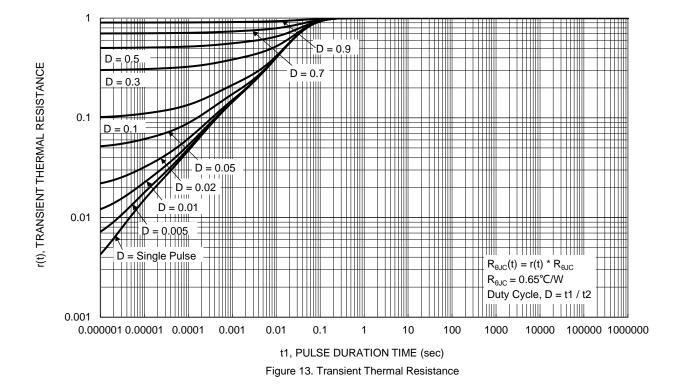


Document number: DS42468 Rev. 4 - 2

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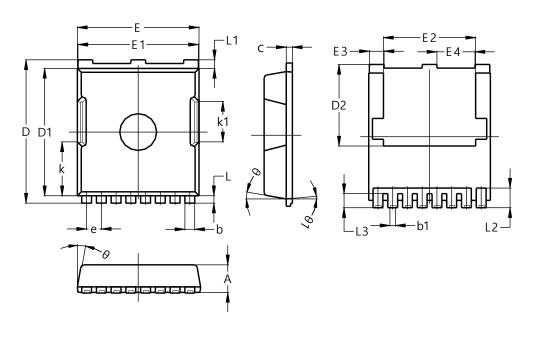






Package Outline Dimensions

Please see http://www.diodes.com/package-outlines.html for the latest version.



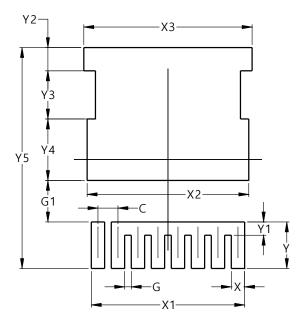
POWERDI1012-8 Dim Min Max Тур 2.20 2.40 2.30 Α b 0.70 0.90 0.80 b1 0.42 0.50 0.45 0.40 0.60 0.50 С D 11.48 11.88 11.68 10.23 D1 10.53 10.38 D2 6.45 6.85 6.65 Ε 9.70 10.10 9.90 9.80 E1 9.70 9.90 E2 7.00 8.00 7.50 E3 1.10 1.30 1.20 E4 3.20 3.00 3.10 1.20 BSC е k 4.39 REF 3.30 REF **k**1 0.50 0.70 L 0.60 L1 0.50 0.90 0.70 L2 1.40 1.80 1.60 L3 1.00 1.15 1.30 θ 0° 15° 10° θ1 00 10° 5° All Dimensions in mm

Suggested Pad Layout

Please see http://www.diodes.com/package-outlines.html for the latest version.

POWERDI1012-8

POWERDI1012-8



Dimensions	Value (in mm)
С	1.200
G	0.400
G1	2.500
Х	0.800
X1	9.200
X2	9.700
Х3	10.100
Y	2.800
Y1	0.800
Y2	1.400
Y3	2.900
Y4	3.700
Y5	13.300

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